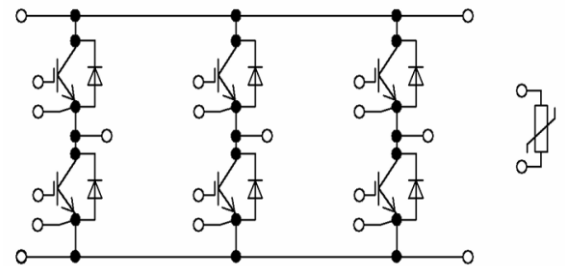


C4 package: 1200V 300A IGBT module



Equivalent
Circuit Schematic

Features:

- Trenchgate Gen.7 IGBT technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High RBSOA capability
- Low static losses: $V_{CE(sat)} = 1,5V@25C$
- Low dynamic losses

OPTIONS:

*** pre-applied TIM**

Typical Applications:

- Motor drives
- Servo Drives

IGBT, Inverter / IGBT

Maximum Rated Values

Collector-emitter Voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current		I_{Cnom}	300	A
	$T_C = 100^{\circ}\text{C}, T_{vjmax} = 175^{\circ}\text{C}$	I_C	370	A
Repetitive Peak Collector Current	$I_{CRM} = 2 \times I_{Cnom}$	I_{CRM}	600	A
Gate-emitter Peak Voltage		V_{GES}	± 20	V

Characteristic Values

min. typ. max.

Collector-emitter Saturation Voltage ¹⁾	$I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	V_{CESat}	—	1.50 1.70 1.78	1.70	V
Gate Threshold Voltage	$V_{CE} = V_{GE}, I_C = 6\text{mA}$	$T_{vj} = 25^{\circ}\text{C}$	V_{GEth}	5.0	6.0	7.0	V
Gate charge	$V_{GE} = -8\text{V} \sim +15\text{V}, V_{CE} = 600\text{V}$	$T_{vj} = 25^{\circ}\text{C}$	Q_G	—	2.55	—	μC
Internal Gate Resistor		$T_{vj} = 25^{\circ}\text{C}$	R_{Gint}	—	1.30	—	Ω
Input Capacitance	$f = 100\text{kHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{V}, V_{GE} = 0\text{V}$		C_{ies}	—	68.5	—	nF
Reverse Transfer Capacitance			C_{res}	—	0.19	—	nF
Collector-emitter Cutoff Current	$V_{CE} = 1200\text{V}, V_{GE} = 0\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{CES}	—	—	200	mA
Gate-emitter Leakage Current	$V_{CE} = 0\text{V}, V_{GE} = 20\text{V}, T_{vj} = 25^{\circ}\text{C}$		I_{GES}	—	—	500	nA
Turn-on Delay Time, Inductive Load	$I_C = 200\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{GON} = 2.0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	t_{don}	—	150 160 165	—	ns
Rise Time, Inductive Load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{GON} = 2.0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	t_r	—	55 70 80	—	ns
Turn-off Delay Time, Inductive Load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 2.0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	t_{doff}	—	340 385 395	—	ns
Fall Time, Inductive Load	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}$ $R_{Goff} = 2.0\Omega$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	t_f	—	140 235 285	—	ns
Turn-on Energy Loss per Pulse	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}, R_{GON} = 2.0\Omega$ $di/dt = 3200\text{A}/\mu\text{s} (T_{vj} = 175^{\circ}\text{C})$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	E_{on}	—	22.9 33.5 40.5	—	mJ
Turn-off energy Loss per Pulse	$I_C = 300\text{A}, V_{CE} = 600\text{V}$ $V_{GE} = \pm 15\text{V}, R_{Goff} = 2.0\Omega$ $dv/dt = 4400\text{A}/\mu\text{s} (T_{vj} = 175^{\circ}\text{C})$	$T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 125^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	E_{off}	—	23.5 34.0 37.0	—	mJ
SC Data	$V_{CE} = 800\text{V},$ $V_{GE} = \pm 15\text{V}$	$t_P \leq 8\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$ $t_P \leq 8\mu\text{s}, T_{vj} = 175^{\circ}\text{C}$	I_{sc}	—	1780 1360	—	A

Thermal Resistance, junction to Case	Per IGBT	R _{thJC}	—	0.095	—	K/W
Temperature under Switching Conditions ²⁾		T _{vj op}	-40		175	°C

Diode, Inverter Maximum Rated Values

Repetitive Peak Reverse Voltage	T _{vj} = 25°C	V _{RRM}	1200	V
Continuous DC Forward Current		I _{Fnom}	300	A
Repetitive Peak Forward Current	I _{FRM} = 2 × I _{F nom}	I _{FRM}	600	A

Characteristic Values

			min.	typ.	max.	
Forward Voltage ¹⁾	I _F = 300A, V _{GE} = 0V T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C	V _F	—	1.85 2.07 2.11	2.20	V
Peak Reverse Recovery Current	I _F = 300A, V _R = 600V -di _F /dt = 3600 A/us (T _{vj} = 175°C) V _{GE} = -15V T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C	I _{RM}	—	200 210 220	—	A
Recovery Charge	I _F = 300A, V _R = 600V -di _F /dt = 3600 A/us (T _{vj} = 175°C) V _{GE} = -15V T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C	Q _R	—	12.5 22.5 29.5	—	μC
Reverse Recovery Energy	I _F = 300A, V _R = 600V -di _F /dt = 3600 A/us (T _{vj} = 175°C) V _{GE} = -15V T _{vj} = 25°C T _{vj} = 125°C T _{vj} = 175°C	E _{rec}	—	4.50 10.5 12.5	—	mJ
Thermal Resistance, junction to Case	Per Diode	R _{thJC}	—	0.174	—	K/W
Temperature under Switching Conditions ²⁾		T _{vj op}	-40	—	175	°C

NTC-Thermistor / NTC Characteristic Values

			min.	typ.	max.	
Rated Resistance	T _{NTC} = 25°C	R ₂₅	—	5	—	KΩ
Deviation of R ₁₀₀	T _C = 100°C, R ₁₀₀ = 465Ω	ΔR/R	-7.3	—	7.3	%
Power Dissipation	T _{NTC} = 25°C	P ₂₅	—	—	10	mW
B-Value	R ₂ = R ₂₅ exp[B _{25/50} (1/T ₂ -1/(298.15K))]	B _{25/50}	—	3380	—	K
	R ₂ = R ₂₅ exp[B _{25/80} (1/T ₂ -1/(298.15K))]	B _{25/80}	—	3470	—	K
	R ₂ = R ₂₅ exp[B _{25/100} (1/T ₂ -1/(298.15K))]	B _{25/100}	—	3520	—	K

Module

Isolation Test Voltage	RMS, f=50Hz, t=1 min	ViSOL	3.0	kV
Material of Module Baseplate			Cu	
Internal Isolation	Basic insulation (class1,IEC 61140)		Al ₂ O ₃	
Creepage Distance	Terminal to heatsink Terminal to terminal		10.0	mm
Clearance	Terminal to heatsink Terminal to terminal		7.5	mm
Comparative Tracking Index ³⁾		CTI	>200	

min. typ. max.

Stray Inductance Module		L _{sCE}	—	23	—	nH
Module Lead Resistance, Terminals-Chip	T _C = 25°C, Per Switch	R _{CC'+EE'}	—	1.8	—	mΩ
Storage Temperature		T _{stg}	-40	—	125	°C
Module Mounting torque	M5	M	3.0	—	6.0	Nm
Weight		G	—	310	—	g

1) Terminal impedance is not included.

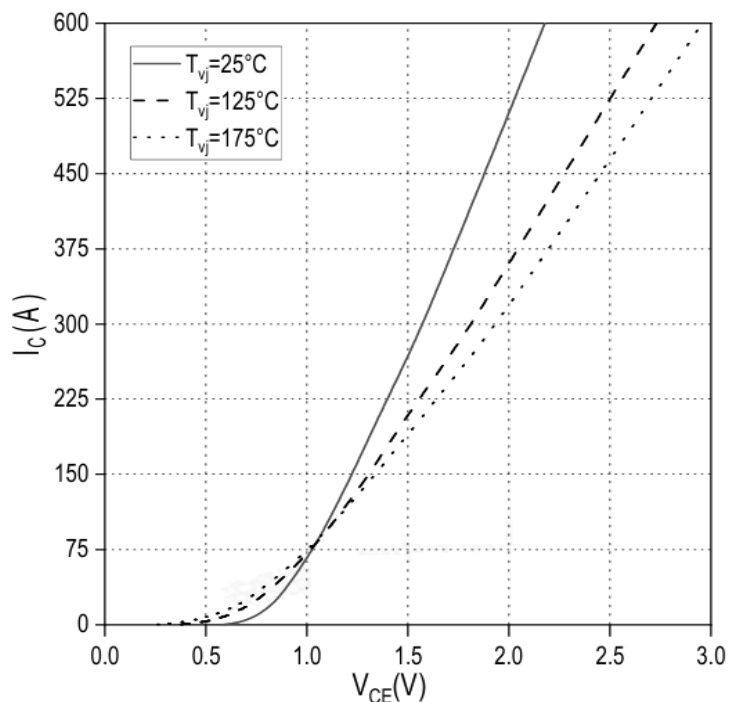
2) T_{vj op} > 150 °C is only allowed for operation at overload conditions.

3) CTI is about 200

Circuit Diagram

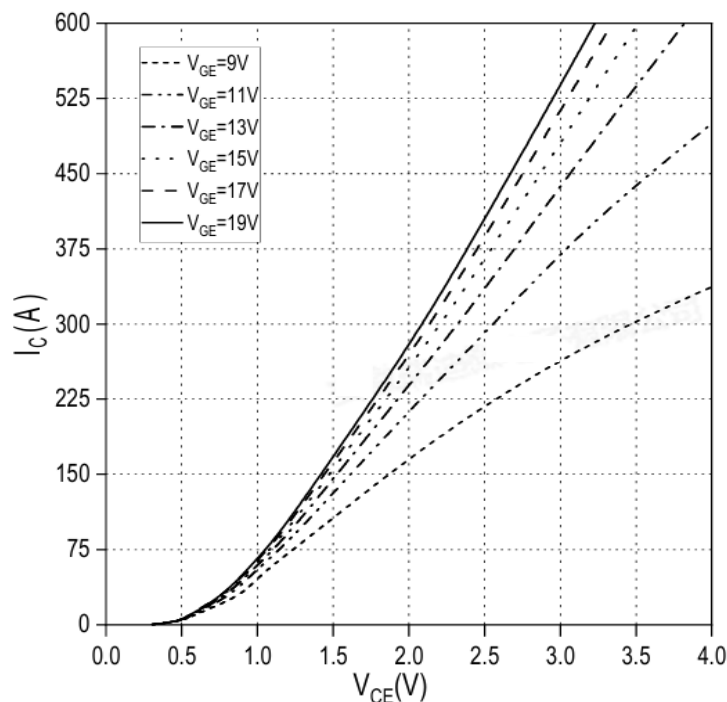
Output characteristic IGBT, Inverter (typical)

$I_c = f(V_{CE})$, $V_{GE} = 15V$



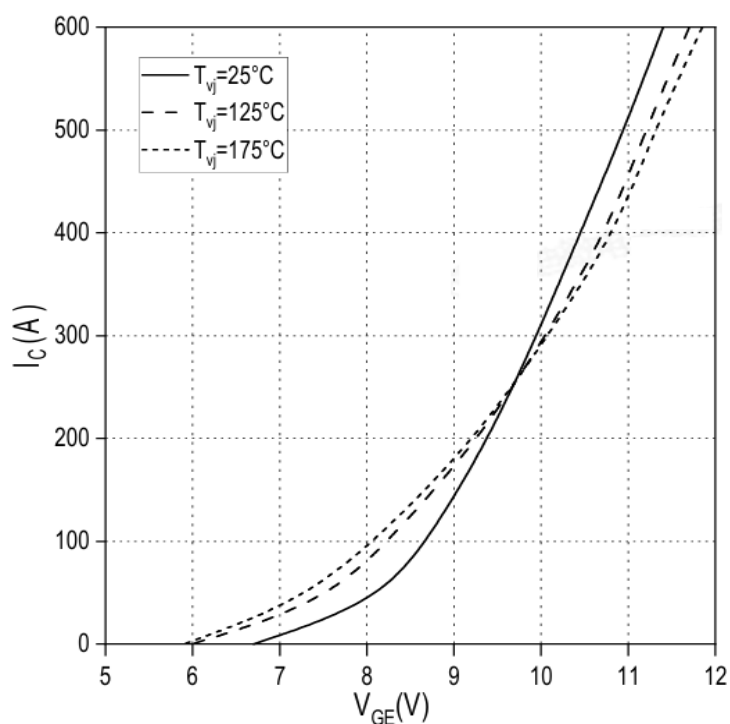
Output characteristic IGBT, Inverter (typical)

$I_c = f(V_{CE})$, $T_{vj} = 175^\circ C$



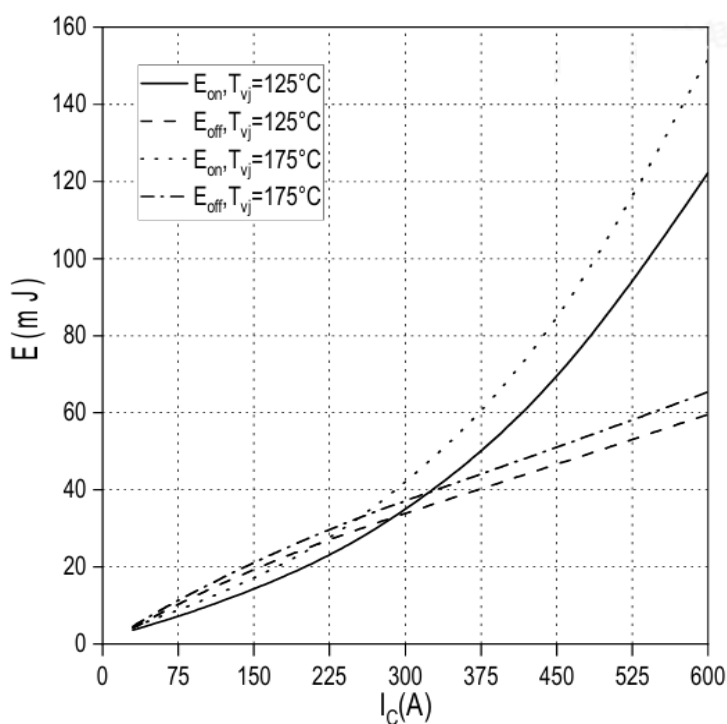
Transfer characteristic IGBT, Inverter (typical),

$I_c = f(V_{GE})$, $V_{CE} = 20V$

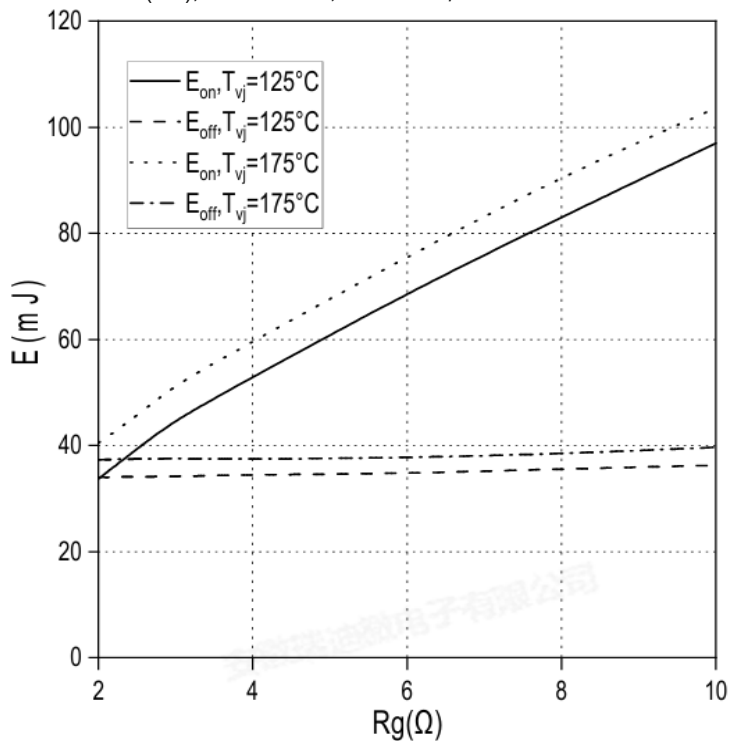


Switching losses IGBT, Inverter (typical)

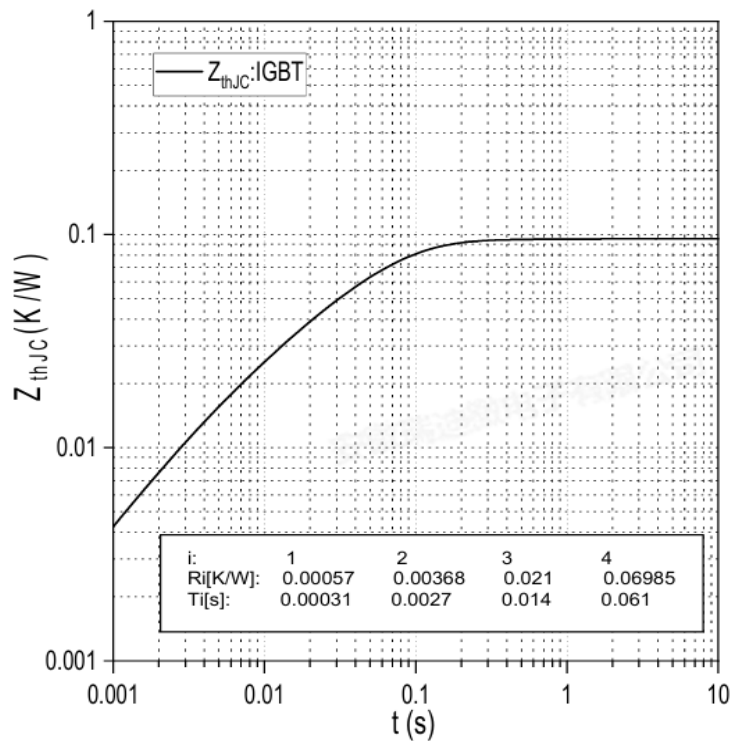
$E_{on} = f(I_c)$, $E_{off} = f(I_c)$, $V_{GE} = \pm 15V$,
 $R_{gon} = 2.0\Omega$, $R_{goff} = 2.0\Omega$, $V_{CE} = 600V$



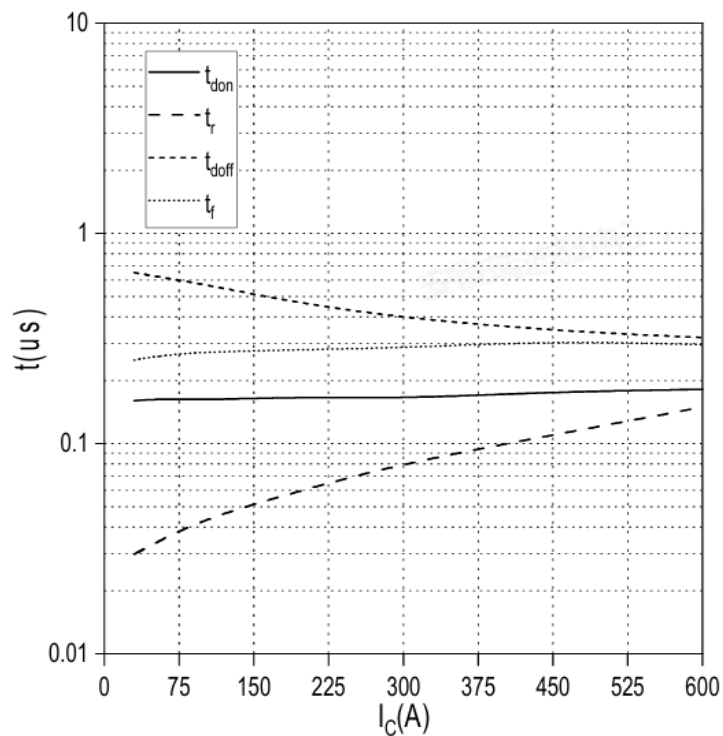
Switching losses IGBT, Inverter(typical)

 $E = f(R_g)$, $V_{GE} = \pm 15V$, $I_C = 300A$, $V_{CE} = 600V$


Transient thermal impedance IGBT, Inverter

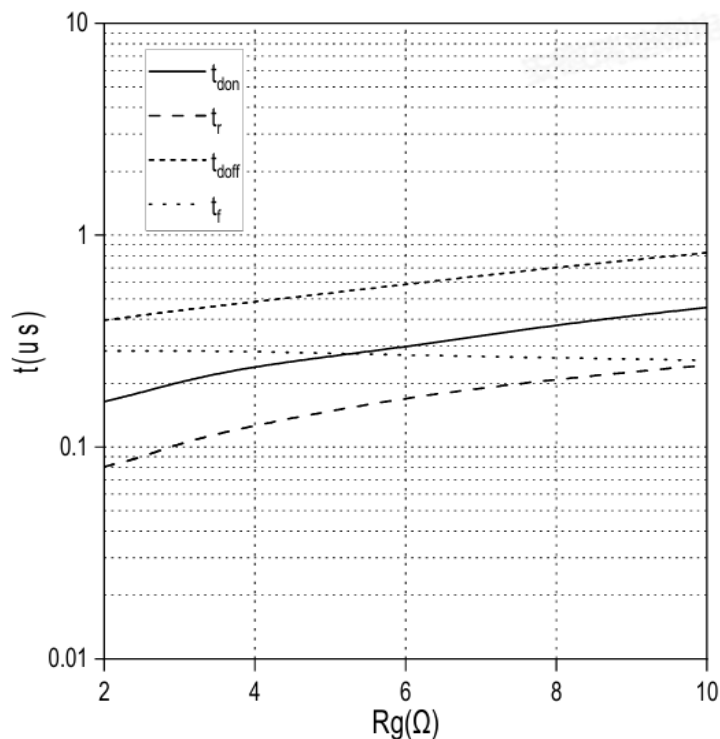
 $Z_{thJC} = f(t)$


Switching time IGBT, Inverter (typical)

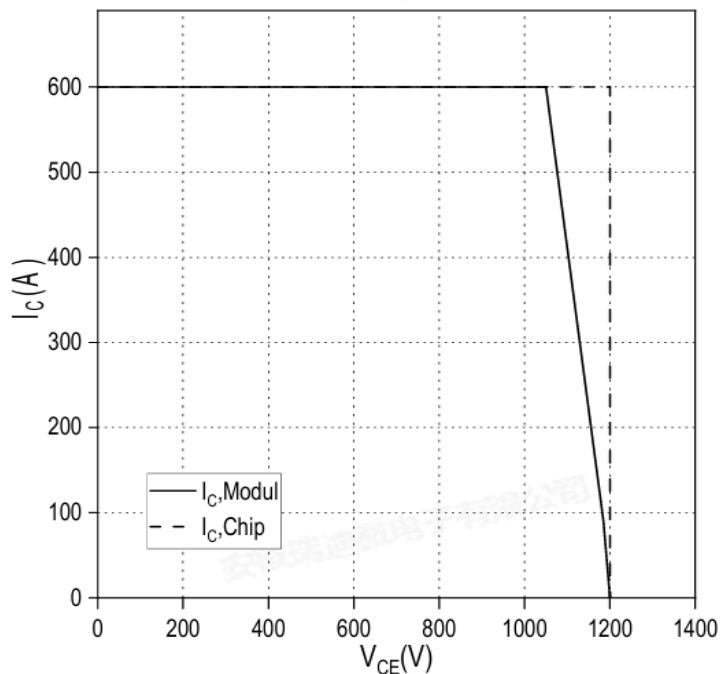
 $t = f(I_C)$
 $R_{goff} = 2.0\Omega$, $R_{gon} = 2.0\Omega$, $V_{CE} = 600V$
 $V_{GE} = \pm 15V$, $T_{vj} = 175^\circ C$


Switching time IGBT, Inverter (typical)

 $t = f(R_g)$
 $I_C = 300A$, $V_{CE} = 600V$,

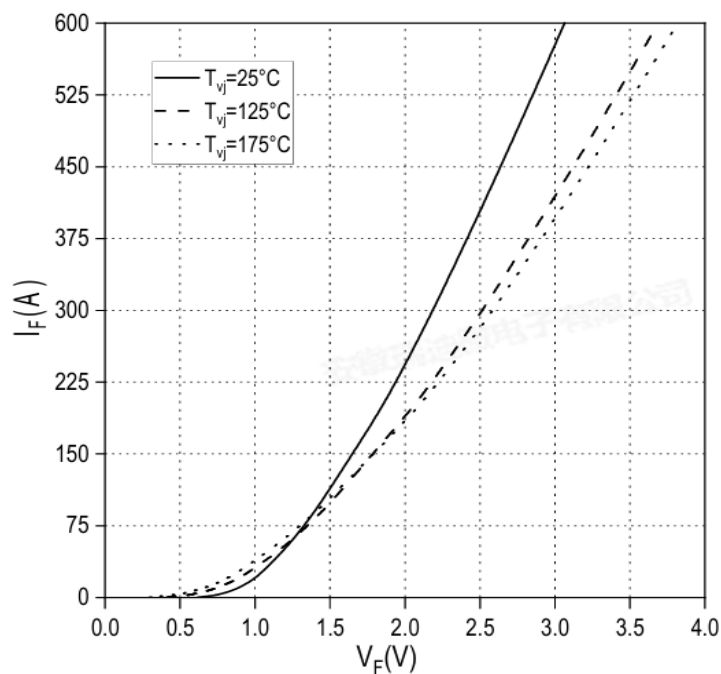
 $V_{GE} = \pm 15V$, $T_{vj} = 175^\circ C$


Reverse bias safe operating area IGBT, Inverter
(RBSOA) $I_C = f(V_{CE})$,
 $V_{GE} = \pm 15V, R_{Goff} = 2.0\Omega, T_{vj} = 175^\circ C$

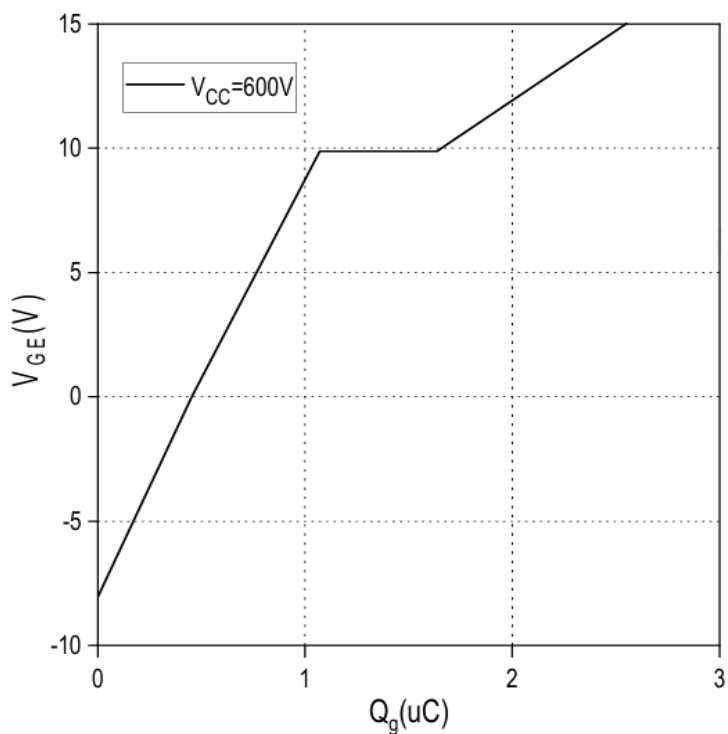


Forward characteristic of Diode, Inverter (typical)

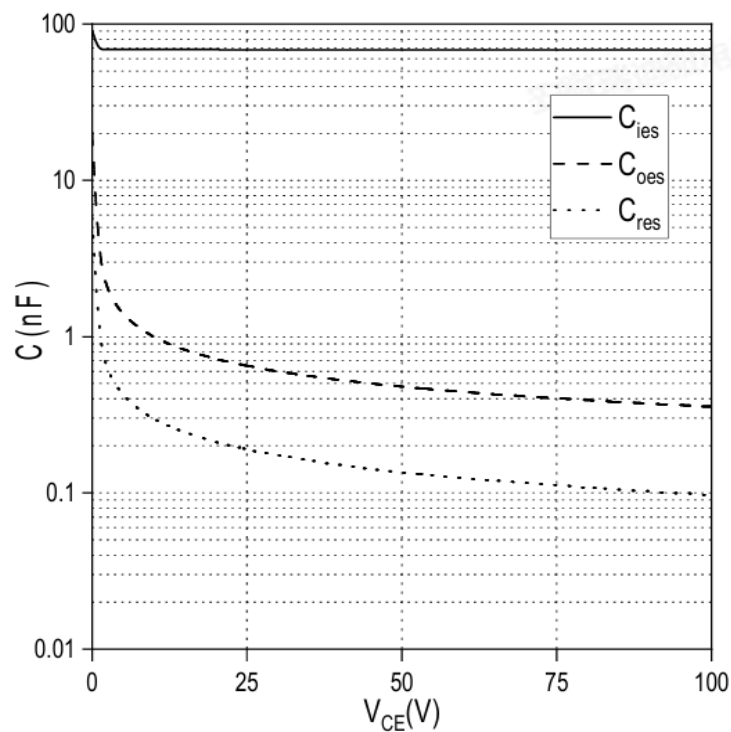
$$I_F = f(V_F)$$



Gate charge characteristic, IGBT, Inverter (typical)
 $V_{GE} = f(Q_g)$
 $I_C = 300A, T_{vj} = 25^\circ C$



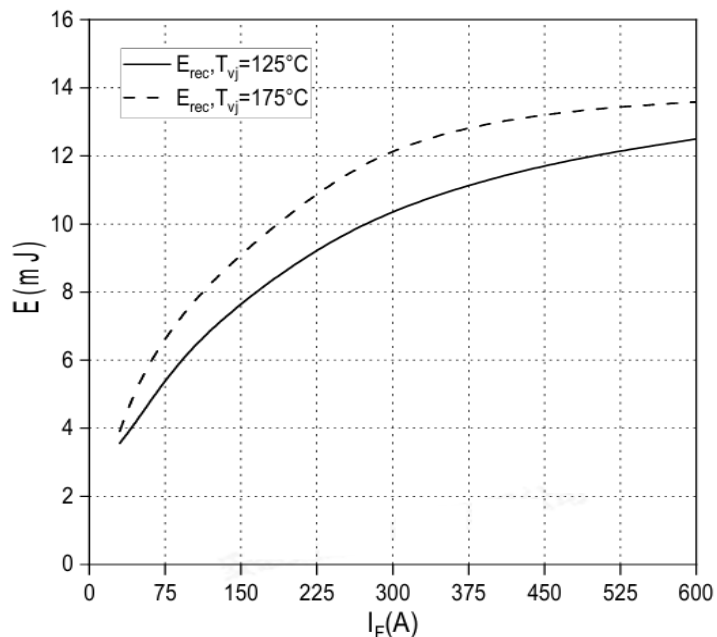
Capacity characteristic, IGBT, Inverter (typical)
 $C = f(V_{CE})$
 $f = 100kHz, V_{GE} = 0V, T_{vj} = 25^\circ C$



Switching losses Diode, Inverter (typical)

$$E_{rec} = f(I_F)$$

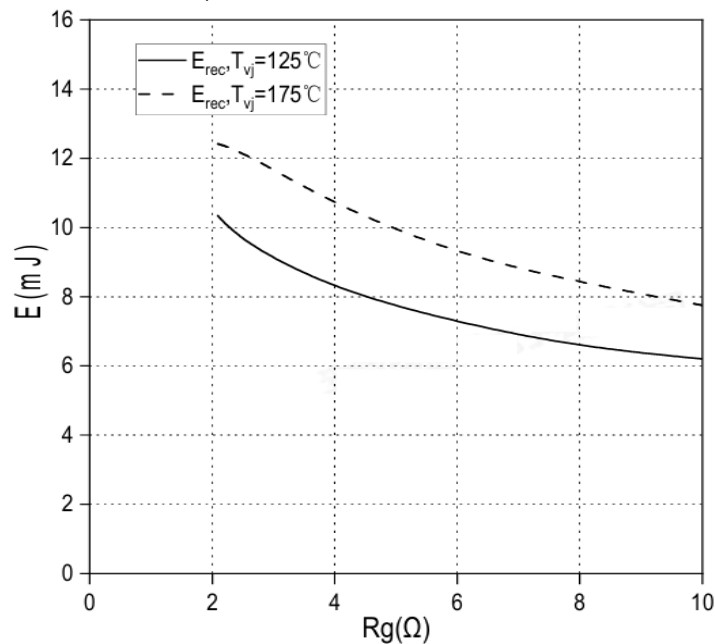
$$R_{Gon} = 2.0\Omega, V_{CE} = 600V$$



Switching losses Diode, Inverter (typical)

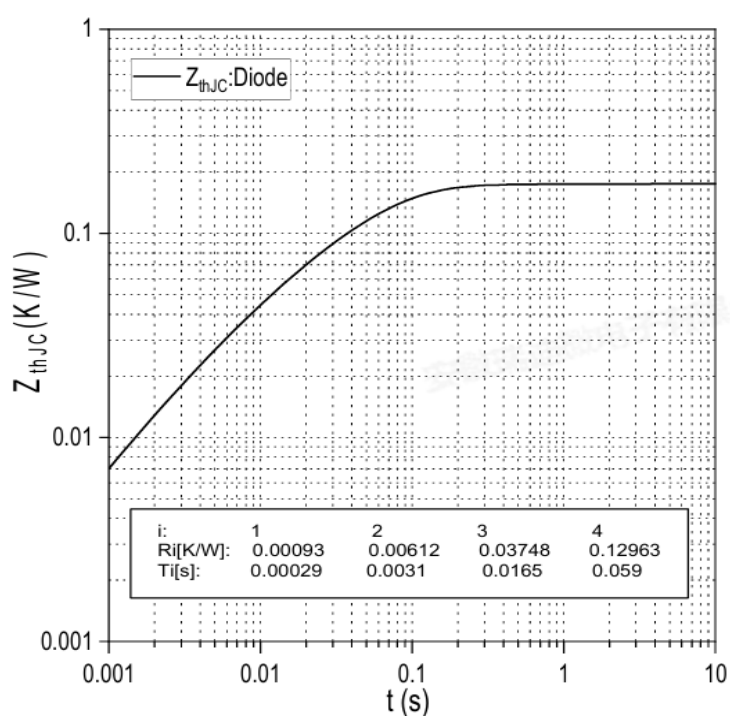
$$E_{rec} = f(R_g)$$

$$I_F = 300A, V_{CE} = 600V$$



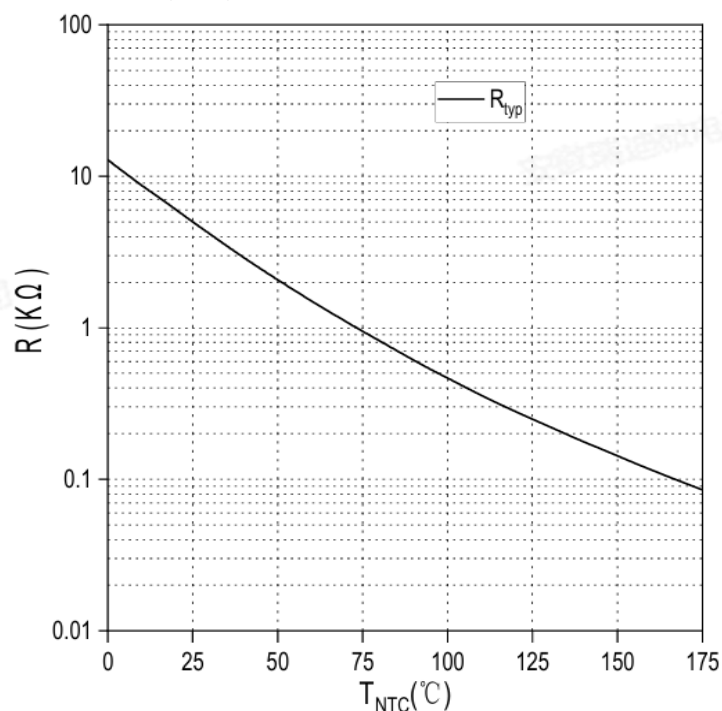
Transient thermal impedance Diode , Inverter

$$Z_{thJC} = f(t)$$



NTC-Thermistor-temperature characteristic

$$R = f(T_{NTC})$$



Technical drawing of a rectangular plate with dimensions and a cross-section view A-A.

Top View Dimensions:

- Overall width: 122.90 ± 0.4
- Overall height: 62.5 ± 0.5
- Inner width: 110.00 ± 0.3
- Inner height: 50 ± 0.3
- Distance from top edge to first hole center: 24.52
- Distance between hole centers: $28.33, 32.14, 47.38, 51.19, 55, 70.24, 74.05, 77.86, 93.1, 96.91$
- Distance from bottom edge to last hole center: 114.06
- Distance from left edge to first hole center: 4.06
- Distance from right edge to last hole center: 11.06

Side View Dimensions:

- Overall height: 17 ± 0.5
- Distance from top edge to first hole center: 3.81 ± 0.5
- Distance from bottom edge to last hole center: 11 ± 0.2
- Distance from top edge to last hole center: 1.6 ± 0.2
- Distance from bottom edge to first hole center: 7 ± 0.5
- Distance from top edge to first hole center: $2.5^{+0.3}_{-0.15}$
- Distance from bottom edge to last hole center: 2.1 ± 0.3

Cross-section A-A:

- Overall width: 0.8 ± 0.05
- Distance from top edge to first hole center: 1.15 ± 0.05

Legend:

* = all dimensions with tolerance of ± 0.5

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